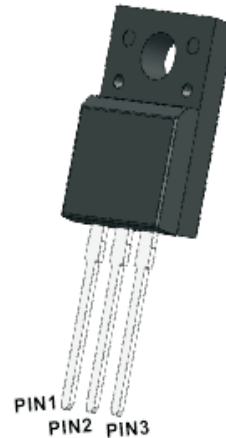




650V,5A,Field Stop , IGBT

TO-220F-3L(\*Prefix :F)

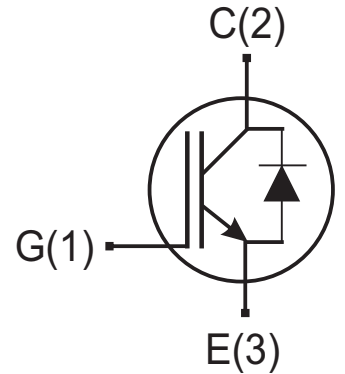
V <sub>CES</sub>	650V
I <sub>c</sub> (T <sub>c</sub> 100°C)	5A
V <sub>CE(sat)</sub> (typ)	1.5V



ROHS  
COMPLIANT

DESCRIPTION

- Positive temperature coefficient
- Low V<sub>CEsat</sub>
- Low saturation voltage
- High switching frequency
- Easy paralleling
- Rohs Compliant



APPLICATIONS

- Motor drives
- Inverters
- Uninterruptible Power Supplies
- Converters

SYMBOL

ABSOLUTE MAXIMUM RATINGS (TA=25°C, unless otherwise specified)

PARAMETER	Symbols	RATINGS	Units
Collector-emitter voltage	V <sub>CES</sub>	650	V
Gate-emitter voltage	V <sub>GES</sub>	±20	V
Continuous Drain Current	I <sub>c</sub>	T <sub>c</sub> =25°C	10
		T <sub>c</sub> =100°C	5
Pulsed Drain Current	I <sub>CM</sub>	20	A
Diode Forward Current	I <sub>F</sub>	T <sub>c</sub> =25°C	10
		T <sub>c</sub> =100°C	5
Power Dissipation (T <sub>c</sub> = 25°C)	P <sub>D</sub>	25	W
Operating junction temperature	T <sub>j</sub>	-55 ~ +150	°C
storage temperature	T <sub>stg</sub>	-55 ~ +150	°C

Thermal Resistance

PARAMETER	Symbols	RATINGS	Units
Thermal resistance IGBT junction – case.	R <sub>thJC</sub>	5.0	°C/W
Thermal resistance Diode junction – case.	R <sub>thJC</sub>	5.0	°C/W
Thermal resistance, junction – ambient	R <sub>thJA</sub>	65	°C/W



**ELECTRICAL CHARACTERISTICS (TA=25°C, unless otherwise specified)**

PARAMETER	Symbols	TEST CONDITIONS	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_{CE}=0.25mA$	650			V
Zero gate voltage collector current	$I_{CES}$	$V_{CE}=650V, V_{GE}=0V$			1	$\mu A$
Gate-emitter leakage current	$I_{GES}$	$V_{GE}=\pm 20V, V_{CE}=0V$			$\pm 100$	nA
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=5A$		1.5	2.0	V
Gate-emitter threshold voltage	$V_{GE(TH)}$	$V_{GE}=V_{CE}, I_C=0.25mA$	4.5		6.5	V
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{ies}$	$V_{CE}=25V,$		259		pF
Output Capacitance	$C_{oes}$	$V_{GE}=0V,$		31.3		pF
Reverse Transfer Capacitance	$C_{res}$	$f=1.0MHz$		10.3		pF
Gate resistance	$R_G$	$V_{DS}=0V, f=1.0MHz$		2.0		$\Omega$
<b>Dynamic</b>						
COSS Stored Energy	$E_{ts}$	$V_{CE}=400V, I_C=5A$		197		mJ
Turn-On Energy ( Body Diode )	$E_{ON}$	$V_{GE}=15V, R_g=60\Omega$		132		mJ
Turn-Off Energy ( Body Diode )	$E_{OFF}$	$T_j=25^\circ C$		65		mJ
Turn-On Delay Time (Note 1)	$t_{D(ON)}$	$V_{CE}=400V, I_C=5A$		22		ns
Turn-On Rise Time	$t_R$	$V_{GE}=15V, R_g=60\Omega$		15		ns
Turn-Off Delay Time	$t_{D(OFF)}$	$T_j=25^\circ C$		104		ns
Turn-Off Fall Time	$t_F$			32		ns
<b>FRD electrical parameters</b>						
Reverse Not Repeating Peak Voltage	$V_{RSM}$	$I_R=5\mu A$		650		V
Forward Voltage Drop	$V_F$	$V_{GE}=0V, I_F=2.5A$		1.5	1.8	V
Reverse Recovery Time	$TRR$	$I_F=0.5A, I_R=1.0A$ $I_{rr}=0.25A$			60	ns
Maximum Reverse Recovery Time	$trr$			70		ns
Maximum Reverse Recovery Current	$IRRM$	$I_F=8A, V_R=400V,$ $dI_F/dt=200A/\mu s$		4.0		A
Reverse Recovery Charge	$QRR$			145		nc

Notes:

1. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .
2. Essentially independent of operating temperature.



### Typical Characteristics

Fig.1 Drain Current vs. Gate-Source Voltage

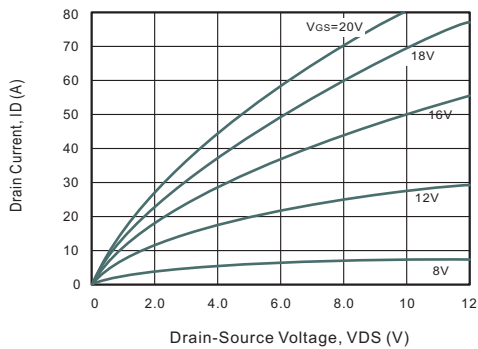


Fig.2 Capacitance Characteristics

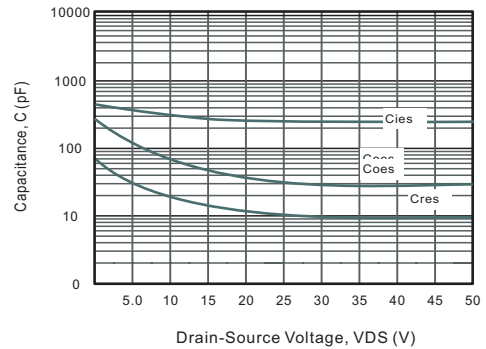


Fig.3 Power Dissipation

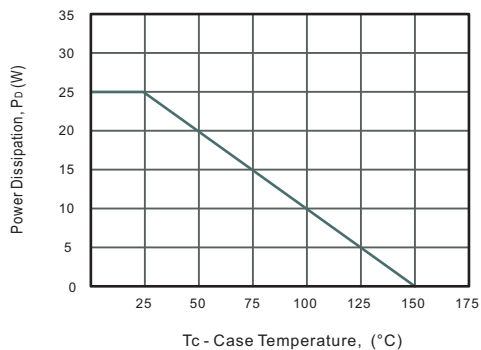


Fig.4 Drain Current Derating

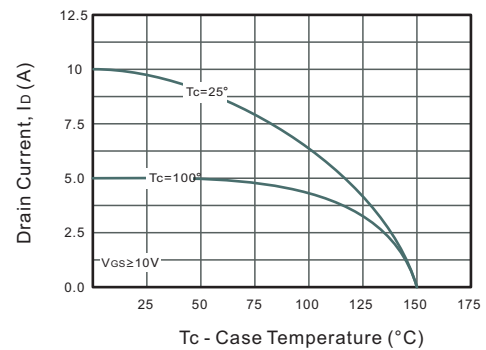
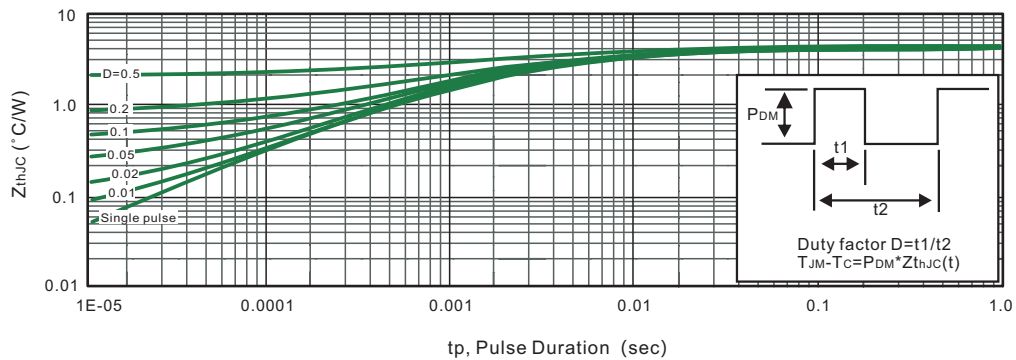


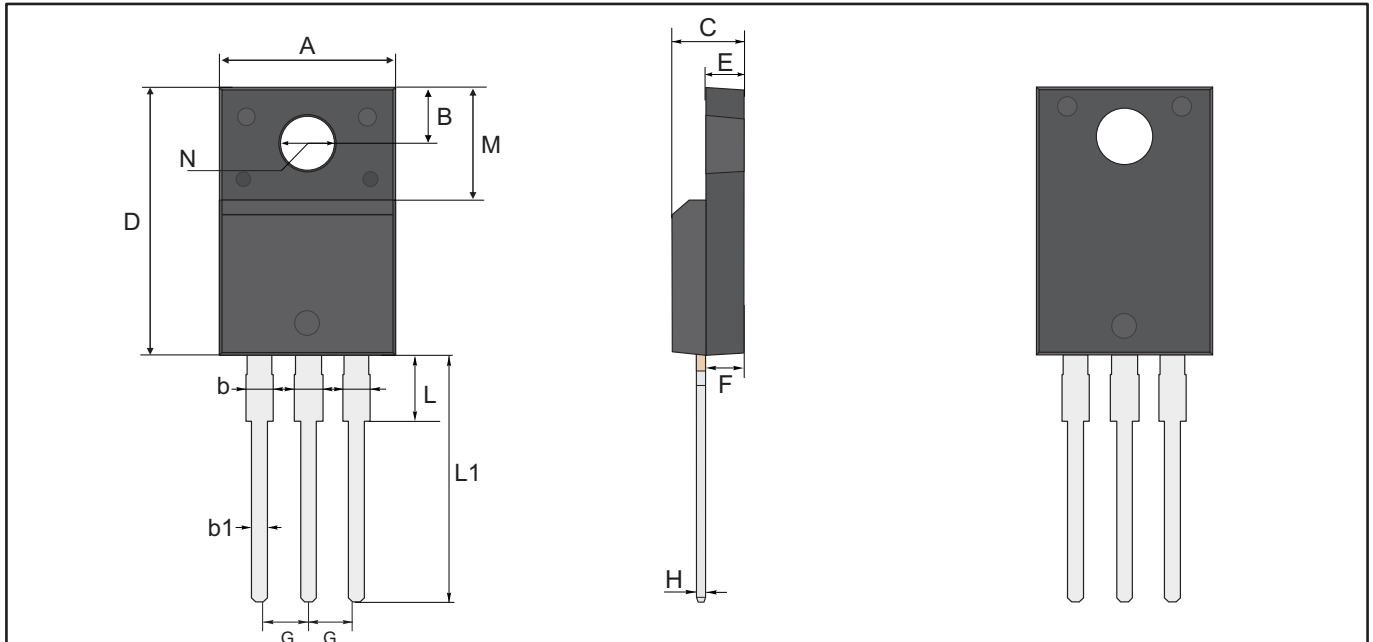
Fig.5 Max. Transient Thermal Impedance





Package Outline  
Through Hole Package ; 3 leads

TO-220F-3L



TO-220F-3L Mechanical data

UNIT		A	B	b	b1	C	D	E	F	G	H	L	L1	M	N
mm	max	10.28	3.37	1.44	0.9	4.9	16.07	2.74	2.74	2.64	0.6	2.85	13.7	6.98	3.18 typ.
	typ	10.18	3.27	1.34	0.8	4.7	15.87	2.54	2.54	2.54	0.5	2.65	13.5	6.68	
	min	10.08	3.17	1.24	0.7	4.5	15.67	2.34	2.34	2.44	0.4	2.45	13.3	6.38	
mil	max	405	133	57	35	193	633	108	108	104	24	112	539	275	125 typ.
	typ	401	129	53	31	185	625	100	100	100	20	104	531	263	
	min	397	125	49	28	177	617	92	92	96	16	96	524	251	

**Marking**

Type number	Marking code
GF05ND65ST	GF05ND65ST



Important Notice and Disclaimer

Jingdao Microelectronics reserves the right to make changes to this document and its products and specifications at any without notice.

Customers should obtain and confirm the latest product information and specifications before final, purchase or use.

Jingdao Microelectronics makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does Jingdao Microelectronics assume any liability for application assistance or customer product design.

Jingdao Microelectronics does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Jingdao Microelectronics.

Jingdao Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of Jingdao Microelectronics.